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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Robert K. Browning	09/30/2010
James Gardner	09/30/2010
Eric T. Martin	09/30/2010
Andrew L. Van Brocklin	09/30/2010
Mark Hunter	09/30/2010

RECEIVING PARTY DATA

Name:	Hewlett-Packard Development Company, L.P.
Street Address:	11445 Compaq Center Drive West
City:	Houston
State/Country:	TEXAS
Postal Code:	77070

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13818421

CORRESPONDENCE DATA

Fax Number: 9707784063

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Address Line 2: Intellectual Property Administration

Address Line 4: Fort Collins, COLORADO 80528

NAME OF SUBMITTER: Terri Walker

Total Attachments: 2

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PATENT REEL: 029911 FRAME: 0248 13818421

CH & AD OD

HEWLETT-PACKARO COMPANY intellectual Property Administrator 3404 E. Harmony Road Mail Stop 35 Fort Collins, Colorado 80528

PATENT APPLICATION

201000317-1 ATTORNEY DOCKET NO.

ASSIGNMENT OF PATENT APPLICATION

I/We, the undersigned (each) have agreed and hereby agree to assign to HEWLETT-PACKARD DEVELOPMENT COMPANY, L.P., a Texas Limited Partnership having its principal place of business in Houston, Texas, (hereinafter HPDC), in furtherance of my/our obligations to the Hewlett-Packard Company and its

subsidiaries and affiliates, and do hereby assign and transfer to HPDC, its successors and assigns, the entire right, title and interest, including the right of priority, in, to and under an application for Letters Patent of the United States THERMAL SENSING FLUID EJECTION ASSEMBLY AND METHOD Filing Date: February 22, 2013 Application No.: 13/818421 and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations in-part (C-li-P's), divisionals, and renewals of and substitutes for said application for said Letters Patent, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefore; and any reissues, or reexaminations, or extensions of said Letters Patent. I/we additionally authorize HPDC to file applications in my/our name for Letters Patent in any country, to be held and enjoyed by HPDC, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Letters Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment, and transfer not been made; AND I/we hereby covenant that I/we have full right to convey the entire interest herein assigned, and that I/ we have not executed and will not execute any agreement in conflict herewith, and I/we further covenant and agree that I/we will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said application and said Letters Patent, to HPDC, its successors, assigns, nominees or egal representatives, and I/we agree to communicate to HPDC, or to its nominee, all known facts respecting said invention(s) or improvement(s), said application and said Letters Patent, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisionals, continuations. C-I-P's, reissue and foreign applications, to make all rightful paths and declarations, and generally to do everything possible to aid HPDC, its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvement(s) in any and all countries provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by HPDC: AND live hereby authorize and request the Commissioner of Patents and Trademarks of the United States. and any official of any country or countries foreign to the United States whose duty it is to issue patents on applications as aforesaid, to issue to HPDC, as assignee of the entire right, title and interest, any and all Letters Patent for said invention(s) or improvement(s), including any and all Letters Patent of the United States which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this assignment. I/we further authorize and direct the attorneys of record to insert the serial number and filing date of said application now identified by the attorney docket number and title set forth above as soon as the same shall have been made known to them by the United States Patent and Trademark Office. Inventor's Signature Robert N. K. Browning Inventor's Typed Name Signature James Gardner inventor's Typed Name Date Application Signed

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HEWLETT-PACKARD COMPANY Intellectual Property Administrator 3404 E. Harmony Road Mail Stop 35 Fort Collins, Colorado 80528

PATENT APPLICATION

ASSIGNMENT OF PATENT APPLICATION (cont.)

ERLT. MARK	9/30/10 Date Assignment Signed
Inventor's Signeture	
Enic Martin Inventor's Typed Name	9/30/10 Date Application Signed
Ondrew L. Van Brocklin Inventor's Types Name	9/30/10 Date Assignment Signed 9/30/10 Date Application Signed
Man Husta	9/30/10 Date Assignment Signed
Mark Hunter	9/30/10
Inventor's Typed Name	Date Application Signed
Inventor's Signature	Date Assignment Signed
Inventor's Typed Name	Date Application Signed
Inventor's Signature	Date Assignment Signed
Inventor's Typed Name	Date Application Signed
Inventor's Signature	Date Assignment Signed
Inventor's Typed Name	Date Application Signed

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